3.044 MATERIALS PROCESSING

LECTURE 3

We will often be comparing heat transfer steps/processes:

When can we neglect one and focus on the other?



Resistance:

$$10 > \frac{\frac{L_A}{k_A}}{\frac{L_B}{k_B}} > 0.1 \implies 10:$$
 "B" conducts fast, cannot sustain a gradient $0.1:$ "A" conducts fast, cannot sustain a gradient

Reduce Dimensionality:

$$\frac{\partial T}{\partial x} = \alpha \, \nabla^2 T : \quad T(t, x, y, z)$$

- 1. Steady State $\frac{\partial T}{\partial t} = 0$
- 2. No Thermal Gradients $\nabla T = 0, \quad T = T(t) \text{ ONLY}$ $\frac{\partial T}{\partial t} = \dots$

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In general, for solid / "fluid" interfaces: $T_2 \neq T_f$

- constant T, B.C. is not appropriate

- fluid cannot always remove heat at the rate it is delivered

How is heat transferred / removed in the fluid?

- conduction: heat moves, atoms sit still
- convection: atoms flow away, carrying heat with them
 - 1. natural convection (T interacts w/ gravity)
 - 2. forced convection (mechanically driven flow)
- radiation: photons carries heat away

What are the proper B.C.?



1. $T_2 \neq T_f$ 2. @x = L, specify flux: $\stackrel{\text{beat}}{\overbrace{q}} = \underbrace{h}_{f}(T_2 - T_f) \quad \Rightarrow \quad \text{the hotter the material is with respect} \\ \text{to the fluid, the faster heat will flow}$ heat transfer coeff. $\left[\frac{W}{m^2 \kappa}\right]$

$$\frac{\partial T}{\partial t} = 0 = \alpha \frac{\partial^2 T}{\partial x^2}$$

Step 1: Solve

$$\frac{T - T_1}{T_2 - T_1} = xL, \text{ where } T_2 \text{ is unknown}$$
$$\Theta = \chi$$

Step 2: B.C.



$$\begin{aligned} @x &= L \\ q_{\text{cond}} &= q_{\text{conv}} \\ -k \frac{\partial T}{\partial x} &= h(T_2 - T_f) \end{aligned}$$

Step 3: Solve for $\frac{\partial T}{\partial x}$

$$\frac{T - T_1}{T_2 - T_1} = \frac{x}{L}$$
$$T = T_1 + \frac{x}{L}(T_2 - T_f)$$
$$\frac{\partial T}{\partial x} = \frac{T_2 - T_1}{L}$$

Plug into: $-k\frac{\partial T}{\partial x} = h(T_2 - T_f)$

$$-k\frac{T_2 - T_1}{L} = h(T_2 - T_f)$$
$$\frac{kT_1}{L} + hT_f = \left(h + \frac{k}{L}\right)$$
$$T_2 = \frac{\frac{k}{L}T_f}{h + \frac{k}{L}}$$

Plug into: $T = T_1 + \frac{x}{L}(T_2 - T_f)$

$$T = T_1 + \frac{x}{L} \left[\frac{\frac{k}{L}T_1 + hT_f}{h + \frac{k}{L}} - T_1 \right]$$
$$T - T_1 = \frac{x}{L} \left[\frac{h(T_f - T_1)}{h + \frac{k}{L}} \right]$$
$$\frac{T - T_1}{T_f - T_1} = \frac{x}{L} \left[\frac{h\frac{L}{k}}{1 + h\frac{x}{L}} \right]$$
$$\Theta = \chi \left[\frac{h\frac{L}{k}}{1 + h\frac{x}{L}} \right]$$

$\frac{hL}{k} \Rightarrow \frac{h}{\frac{k}{l}} \Rightarrow \frac{\frac{L}{k}}{\frac{1}{h}}$	where $\frac{L}{k}$ is conductive resistance and $\frac{1}{h}$ is convective resistance
Biot Number: $\frac{hL}{k}$	dimensionless, ratio of resistances



Three Important Cases:



Generalize:

1. Imperfect interfaces:



$$q_{in} = q_{out}$$

= $h(T_2^+ - T_2^-)$, where $\frac{1}{h}$ = interface resistance

2. Geometry:

$$\begin{split} \frac{hL}{k} &\to \text{What is L?} \\ L &\approx \frac{\text{volume}}{\text{surface area}}, \text{ a characteristic dimension} \end{split}$$

Examples:

- 1. plate heated on one side: L = thickness
- 2. plate heated on both sides: L = half thickness 3. cylinder: $L = \frac{\pi R^2 l}{2\pi R l} = \frac{R}{2}$ $\frac{4}{2}\pi R^3 R$ 4. sphere (or other 3D shape): $L = \frac{\frac{4}{3}\pi R^3}{4\pi R^2} = \frac{R}{3}$

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